Medium-Power Plastic NPN Silicon Transistors

These high-performance plastic devices are designed for driver circuits, switching, and amplifier applications.

Features

- Low Saturation Voltage
- Excellent Power Dissipation
- Excellent Safe Operating Area
- Complement to PNP 2N4920G
- These Devices are Pb-Free and are RoHS Compliant**

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|-----------------------------------|----------------|------------|
| Collector-Emitter Voltage 2N4921G 2N4922G 2N4923G | V _{CEO} | 40 60 80 | Vdc |
| Collector-Emitter Voltage 2N4921G 2N4922G 2N4923G | V _{CB} | 40 60 80 | Vdc |
| Emitter Base Voltage | V _{EB} | 5.0 | Vdc |
| Collector Current – Continuous (Note 1) | Ic | 1.0 | Adc |
| Collector Current – Peak (Note 1) | I _{CM} | 3.0 | Adc |
| Base Current - Continuous | Ι _Β | 1.0 | Adc |
| Total Power Dissipation @ T _C = 25°C Derate above 25°C | P _D | 30 0.24 | W mW/°C |
| Operating and Storage Junction Temperature Range | T _J , T _{stg} | -65 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

The 1.0 A maximum I_C value is based upon JEDEC current gain requirements.
 The 3.0 A maximum value is based upon actual current handling capability of the device (see Figures 5 and 6).

THERMAL CHARACTERISTICS (Note 2)

| | Characteristic | Symbol | Max | x Unit | |
|---|--------------------------------------|-----------------|------|--------|--|
| ĺ | Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 4.16 | °C/W | |

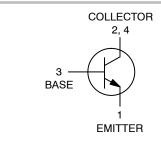
2. Recommend use of thermal compound for lowest thermal resistance. *Indicates JEDEC Registered Data.



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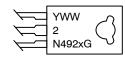
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1.0 AMPERE GENERAL PURPOSE POWER TRANSISTORS 40-80 VOLTS, 30 WATTS





MARKING DIAGRAM



Y = Year WW = Work Week 2N492x = Device Code x = 1, 2, or 3 G = Pb-Free Package

ORDERING INFORMATION

| Device | Package | Shipping | | | | |
|---------|---------------------|-----------------|--|--|--|--|
| 2N4921G | TO-225 (Pb-Free) | 500 Units / Box | | | | |
| 2N4922G | TO-225 (Pb-Free) | 500 Units / Box | | | | |
| 2N4923G | TO-225 (Pb-Free) | 500 Units / Box | | | | |

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|---|-----------------------|----------------|---------------|------|
| OFF CHARACTERISTICS | <u> </u> | | • | 1 |
| Collector-Emitter Sustaining Voltage (Note 3) (I _C = 0.1 Adc, I _B = 0) 2N4921G 2N4922G 2N4923G | V _{CEO(sus)} | 40 60 80 | - - - | Vdc |
| Collector Cutoff Current (V _{CE} = 20 Vdc, I _B = 0) 2N4921G (V _{CE} = 30 Vdc, I _B = 0) 2N4922G | I _{CEO} | - | 0.5 0.5 | mAdc |
| (V _{CE} = 40 Vdc, I _B = 0) 2N4923G | | - | 0.5 | |
| Collector Cutoff Current $(V_{CE} = Rated\ V_{CEO},\ V_{EB(off)} = 1.5\ Vdc)$ $(V_{CE} = Rated\ V_{CEO},\ V_{EB(off)} = 1.5\ Vdc,\ T_{C} = 125^{\circ}C$ | ICEX | - - | 0.1 0.5 | mAdc |
| Collector Cutoff Current (V _{CB} = Rated V _{CB} , I _E = 0) | I _{CBO} | _ | 0.1 | mAdc |
| Emitter Cutoff Current (V _{EB} = 5.0 Vdc, I _C = 0) | I _{EBO} | _ | 1.0 | mAdc |
| ON CHARACTERISTICS | | | • | • |
| DC Current Gain (Note 3) $ \begin{aligned} &(I_C=50 \text{ mAdc, } V_{CE}=1.0 \text{ Vdc)} \\ &(I_C=500 \text{ mAdc, } V_{CE}=1.0 \text{ Vdc)} \\ &(I_C=1.0 \text{ Adc, } V_{CE}=1.0 \text{ Vdc)} \end{aligned} $ | h _{FE} | 40 30 10 | - 150 - | - |
| Collector-Emitter Saturation Voltage (Note 3) (I _C = 1.0 Adc, I _B = 0.1 Adc) | V _{CE(sat)} | - | 0.6 | Vdc |
| Base–Emitter Saturation Voltage (Note 3) $(I_C = 1.0 \text{ Adc}, I_B = 0.1 \text{ Adc})$ | V _{BE(sat)} | - | 1.3 | Vdc |
| Base–Emitter On Voltage (Note 3) $(I_C = 1.0 \text{ Adc}, V_{CE} = 1.0 \text{ Vdc})$ | V _{BE(on)} | - | 1.3 | Vdc |
| SMALL-SIGNAL CHARACTERISTICS | - | | • | + |
| Current-Gain - Bandwidth Product (I _C = 250 mAdc, V _{CE} = 10 Vdc, f = 1.0 MHz) | f _T | 3.0 | - | MHz |
| Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 100 kHz) | C _{ob} | _ | 100 | pF |
| Small-Signal Current Gain (I _C = 250 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz) | h _{fe} | 25 | - | - |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. Pulse Test: PW \approx 300 μ s, Duty Cycle \approx 2.0%.

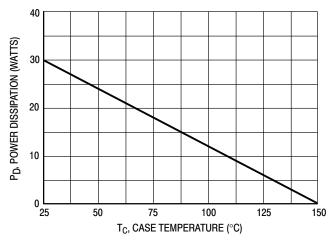


Figure 1. Power Derating

Safe Area Curves are indicated by Figure 5. All limits are applicable and must be observed.

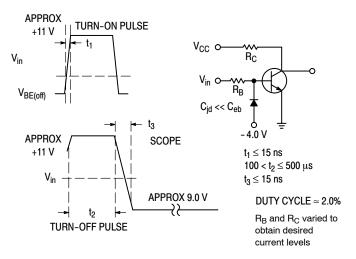


Figure 2. Switching Time Equivalent Circuit

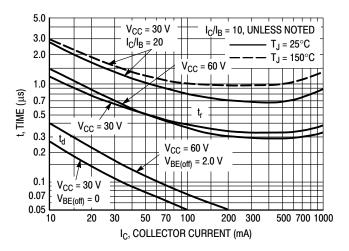


Figure 3. Turn-On Time

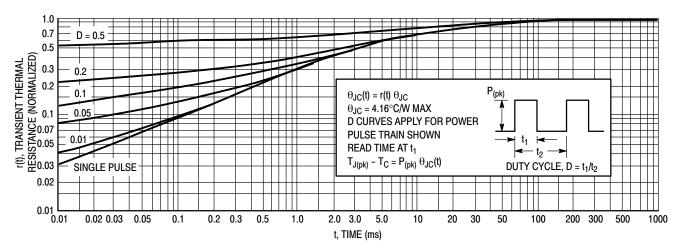


Figure 4. Thermal Response

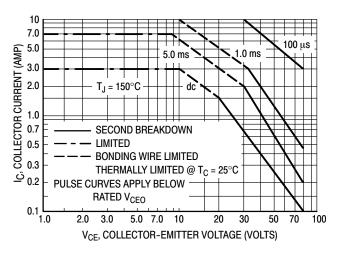


Figure 5. Active-Region Safe Operating Area

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ operation i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 5 is based on $T_{J(pk)} = 150^{\circ} C$; T_{C} is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(pk)} \le 150^{\circ} C$. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

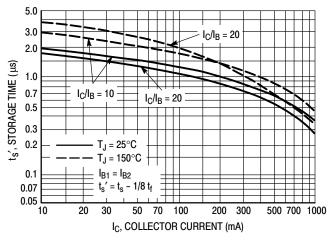


Figure 6. Storage Time

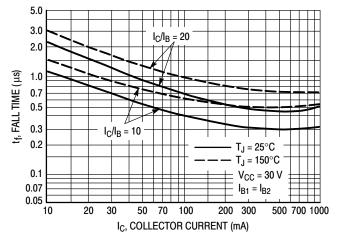
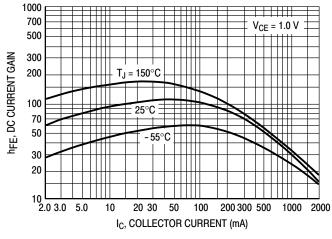


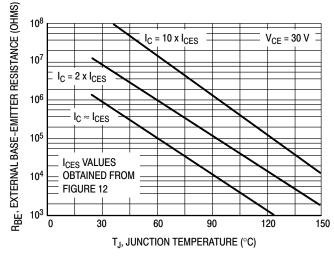
Figure 7. Fall Time



V_{CE}, COLLECTOR-EMITTER VOLTAGE (VOLTS) $I_{C} = 0.1 A$ 0.25 A 0.5 A 1.0 A 8.0 $T_J = 25^{\circ}C$ 0.6 0.4 0.2 0.2 0.3 0.5 20 30 50 2.0 3.0 5.0 10 100 200 IB, BASE CURRENT (mA)

Figure 8. Current Gain

Figure 9. Collector Saturation Region



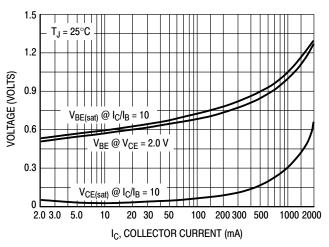
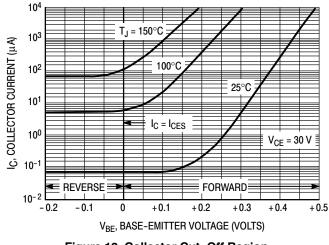


Figure 10. Effects of Base-Emitter Resistance

Figure 11. "On" Voltage



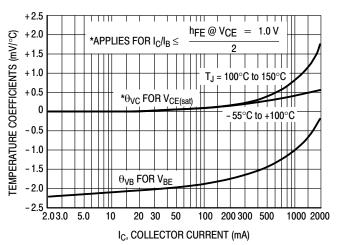
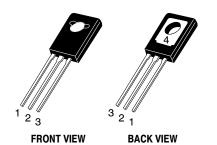


Figure 12. Collector Cut-Off Region

Figure 13. Temperature Coefficients

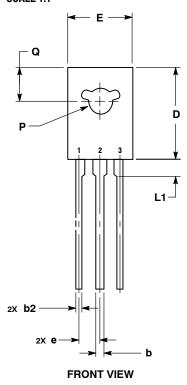
MECHANICAL CASE OUTLINE



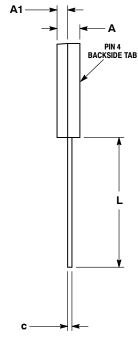
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SCALE 1:1



STYLE 2:



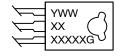
SIDE VIEW

STYLE 4:

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. NUMBER AND SHAPE OF LUGS OPTIONAL.

| | MILLIMETERS | | | | |
|-----|-------------|-------|--|--|--|
| DIM | MIN | MAX | | | |
| Α | 2.40 | 3.00 | | | |
| A1 | 1.00 | 1.50 | | | |
| b | 0.60 | 0.90 | | | |
| b2 | 0.51 | 0.88 | | | |
| С | 0.39 | 0.63 | | | |
| D | 10.60 | 11.10 | | | |
| E | 7.40 | 7.80 | | | |
| е | 2.04 | 2.54 | | | |
| L | 14.50 | 16.63 | | | |
| L1 | 1.27 | 2.54 | | | |
| P | 2.90 | 3.30 | | | |
| Q | 3.80 | 4.20 | | | |

GENERIC MARKING DIAGRAM*



= Year WW = Work Week

XXXXX = Device Code = Pb-Free Package

STYLE 5:

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

| 2., 4. | EMITTER COLLECTOR BASE | 2., 4. | CATHODE ANODE GATE | 2., 4. | BASE COLLECTOR EMITTER | 2., 4. | ANODE 1 ANODE 2 GATE | PIN 1. 2., 4. 3. | |
|----------|------------------------------|--------------------|--------------------------|----------|------------------------------|----------|----------------------------|------------------------|--------|
| STYLE 6: | CATHODE | STYLE 7: PIN 1. | | STYLE 8: | SOURCE | STYLE 9: | GATE | STYLE 10: | SOURCE |
| | GATE | | GATE | | GATE | | DRAIN | | DRAIN |
| | ANODE | | MT 2 | | DRAIN | | SOURCE | 2., 4. | |

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